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**Complete if Known**

Application Number	10/571,044
Filing Date	March 3, 2006
First Named Inventor	Takashi Oku
Group Art Unit	2875
Examiner Name	Mary Zettl
Attorney Docket Number	075834.00553

Sheet 1 of 1

**U.S. PATENT DOCUMENTS**

Examiner Initials <sup>1</sup>	Cite No. <sup>1</sup>	U.S. Patent Document Number <sup>2</sup> Kind Code <sup>3</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
	US1				
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**FOREIGN PATENT DOCUMENTS**

Examiner Initials <sup>1</sup>	Cite No. <sup>1</sup>	Foreign Patent Document Office <sup>3</sup> Number <sup>4</sup> Kind Code <sup>5</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Ts
/M.Z./	F1	JP 2001-112777	Olympus Optical Co Ltd	04/24/2001		
/M.Z./	F2	JP 11-038207	Dainippon Printing Co Ltd	02/12/1999		
/M.Z./	F3	JP 08-335044	Dainippon Printing Co Ltd	12/17/1996		
/M.Z./	F4	JP 08-254604	Omron Corp	10/01/1996		
/M.Z./	F5	JP 08-184704	Sekisui Chem Co Ltd	07/16/1996		
/M.Z./	F6	JP 08-062428	Dainippon Printing Co Ltd	03/08/1996		
/M.Z./	F7	JP 06-301021	Hitachi Ltd	10/28/1994		
/M.Z./	F8	JP 06-201904	Dainippon Printing Co Ltd	07/22/1994		
/M.Z./	F9	JP 05-061120	Kuraray Co Ltd	03/12/1993		
	F10					

Examiner Signature	/Mary Zettl/	Date Considered	05/16/2008
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SONY REF.	US SERIAL NO.	IDS TIMING
S04P1318US00	10/571044	OA (JP)

## CORRESPONDING JAPANESE PATENT APPLICATION

JP	2003 - 338308	OA issued on: 2008/2/7	[HQ-CASE]
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## PATENT DOCUMENT(S)

ENGLISH EQUIVALENT

/M.Z./	1	JPA	HEI	05 - 173134	cited	( JPA	1993 173134	)	
/M.Z./	2	JPA		2003 - 240921	cited	( JPA	2003 240921	)	
/M.Z./	3	JPA		2000 - 030515	cited	( JPA	2000 030515	)	
/M.Z./	4	JPA	HEI	09 - 101405	cited	( JPA	1997 101405	)	
/M.Z./	5	JPA	HEI	06 - 018707	cited	( JPA	1994 018707	)	
/M.Z./	6	JPA	HEI	06 - 222207	cited	( JPA	1994 222207	)	
/M.Z./	7	JPA	HEI	09 - 269418	cited	( JPA	1997 269418	)	
/M.Z./	8	JPA	HEI	07 - 270603	cited	( JPA	1995 270603	)	
/M.Z./	9	JPA	HEI	07 - 270708	cited	( JPA	1995 270708	)	
/M.Z./	10	JPA	HEI	08 - 335044		( JPA	1996 335044	)	
/M.Z./	11	JPA	HEI	08 - 313708	cited	( JPA	1996 313708	)	
/M.Z./	12	JPA	HEI	08 - 184704		( JPA	1996 184704	)	
/M.Z./	13	JPA	HEI	08 - 062428		( JPA	1996 062428	)	
/M.Z./	14	JPA	HEI	06 - 201904		( JPA	1994 201904	)	
/M.Z./	15	JPA	HEI	11 - 038207		( JPA	1999 038207	)	
/M.Z./	16	JPA	HEI	06 - 301021		( JPA	1994 301021	)	
/M.Z./	17	JPA	HEI	05 - 061120		( JPA	1993 061120	)	
/M.Z./	18	JPA		2001 - 112777		( JPA	2001 112777	)	
/M.Z./	19	JPA	HEI	08 - 254604		( JPA	1996 254604	)	
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## NON-PATENT DOCUMENT(S)

ENGLISH

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